Sheet 1 of 2 Applic. No. M PTO-1449 (SUBSTITUTE) Attorney Docket No.: P2000,0361 10/609.464 S. DEPARTMENT OF COMMERCE ATENT AND TRADEMARK OFFICE Applicant Wolfgang Dickenscheid et al. INFORMATION DISCLOSURE STATEMENT BY APPLICANT Filing Date Group Art Unit (37 CFR 1.98(b)) June 27, 2003 **U.S. PATENT DOCUMENTS** EXAMINER SUB FILING **PATENTEE INITIALS** PATENT NO. DATE **CLASS CLASS** DATE Α В С D Ε F G Н FOREIGN PATENT DOCUMENT TRANSL. SUB DOCUMENT NO. DATE COUNTRY CLASS **CLASS** YESINO K L M Ν OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.) J. Tony Pan et al.: "Planarization and Integration of Shallow Trench Isolation". 1998 Proceedings of the Fifteenth International VLSI Multilevel Interconnection Conference (VMIC), Santa Clara, CA, June 16-18, 1998, pp. 467-472 P George Y. Liu et al.: "Chip-Level CMP Modeling and Smart Dummy for HDP and Conformal CVD Films", 1999 Proceedings of the Fourth International Chemical-Mechanical Planarization for ULSI Multilevel Interconnection Conference (CMP-MIC), Santa Clara, CA, February 11-12, 1999, pp. 120-127 **EXAMINER** DATE CONSIDERED EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with

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> INFORMATION DISCLOSURE STATEMENT BY APPLICANT (37 CFR 1.98(b))

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**Applicant** 

Wolfgang Dickenscheid et al.

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## U.S. PATENT DOCUMENTS

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OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)

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Valeriy Sukharev: "Addressing the pattern density effects in deposition, etch and CMP by means of simulations", 2001 Proceedings of the Sixth International Chemical-Mechanical Planarization for ULSI Multilevel Interconnection Conference (CMP-MIC), Santa Clara, CA, March 7-9, 2001, pp. 403-413

Carsten Schmitz et al.: "CMPSIM – Ein Simulator für den Planarisierungsprozess auf Layout Ebene" [ CMPSIM – a simulator for the planarization process on the layout level], internal memo, Infineon Technologies AG, München, November 26, 1999, pp. 1-17

**EXAMINER** 

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EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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عد		Smith, T.H.: "A CMP Model Combining Density and Time Dependencies", Proc.CMP-MIC, 1999, 8 pages						
2				ed Characterization ", Massachusetts In				
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FORM PTO-1449 (SUBSTITUTE)  U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE  INFORMATION DISCLOSURE STATEMENT BY APPLICANT (37 CFR 1.98(b))			Attorney Docket No.: P2000,0361 Appl. No.:  Applicant: WOLFGANG DICKENSCHEID ET AL.  Filing Date: June 27, 2003 Group Art Unit:						
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OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)									
2	Stine, B. et al.: "A Closed-Form Analytic Model for ILD Thickness Variation in CMP Processes", Proc.CMP-MIC, 1997, pp. 1-7								
EXAMINER DATE CONSIDERED									
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